

EDSP2X-x

25G SFP28 Direct Attach Cable (DAC)

PRODUCT FEATURES

- > Up to 25.78125 Gbps data rate
- > Up to 5 meter transmission
- > Hot-pluggable SFP 20PIN footprint
- > Improved Pluggable Form Factor(IPF)
- > compliant for enhanced EMI/EMC performance
- Compatible to SFP28 MSA
- > Compatible to SFF-8402 and SFF-8432
- > Temperature Range: 0~ 70 °C
- > RoHS Compatible

APPLICATIONS

- > Cost-effective copper solution
- Lowest total system power solution
- > Lowest total system EMI solution
- > Optimized design for Signal Integrity
- > High density connections between networking equipment
- 25G Ethernet





DESCRIPTIONS

ETU-LINK's SFP28 Direct Attach Cables are compliant with SFF-8432 and SFF-8402 specifications. Various choices of wire gauge are available from 30 to 26 AWG with various choices of cable length (up to 5m). The SFP28 passive cable assemblies are high performance, cost effective I/O solutions for 25G Ethernet. SFP28 copper cables allow hardware manufactures to achieve high port density, configurability and utilization at a very low cost and reduced power budget.

Ordering Information

Part No.	Description			
EDSP2X-x-30	25G SFP28 Direct Attach Cable (DAC) 1~3M 30AWG			
EDSP2X-x-26	25G SFP28 Direct Attach Cable (DAC) 3~5M 26AWG			

Notes:

- 1. where "x" denotes cable length in meters. Examples are as follows:
- 2. x = 1 for 1m,

High Speed Characteristics

Notes:

Parameter	Symbol	Min	Typical	Max	Unit	Note
Differential Impedance	TDR	90	100	110	Ω	
Insertion loss	SDD21	-22.48			dB	At 12.8906 GHz
Differential Return Loss	SDD11 SDD22			See 1	dB	At 0.05 to 4.1 GHz
Differential Actum 2033				See 2	dB	At 4.1 to 19 GHz
Common-mode to common-mode output return loss	SCC11 SCC22			-2	dB	At 0.2 to 19 GHz
Differential to common-mode return loss	SCD11 SCD22			See 3	dB	At 0.01 to 12.89 GHz
returnioss				See 4		At 12.89 to 19 GHz
Differential to account of Made				-10	dB	At 0.01 to 12.89 GHz
Differential to common Mode Conversion Loss	SCD21-IL			See 5		At 12.89 to 15.7 GHz
				-6.3		At 15.7 to 19 GHz

1. Reflection Coefficient given by equation SDD11(dB) < -16.5 + 2 × SQRT(f), with f in GHz

2. Reflection Coefficient given by equation SDD11(dB) < -10.66 + 14 × log10(f/5.5), with f in GHz



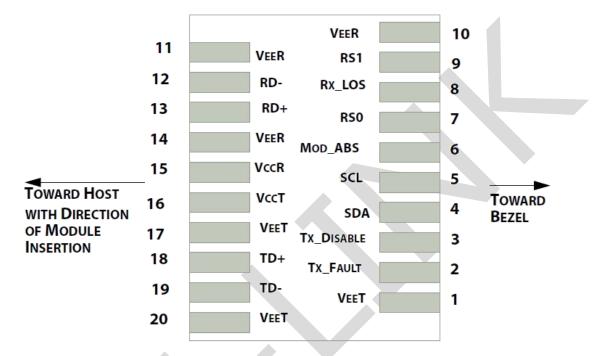
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3. Reflection Coefficient given by equation SCD11(dB) < -22 + (20/25.78)*f, with f in GHz

4. Reflection Coefficient given by equation SCD11(dB) < -15 + (6/25.78)*f, with f in GHz

5. Reflection Coefficient given by equation SCD21(dB) < -27 + (29/22)*f, with f in GHz

Pin Diagram



PIN #	Name	Function	Notes		
1	VeeT	Module transmitter ground	1		
2	Tx Fault	Module transmitter fault	2		
3	Tx Disable	Transmitter Disable; Turns off transmitter laser output	3		
4	SDL	2 wire serial interface data input/output (SDA)	4		
5	SCL	2 wire serial interface clock input (SCL)	4		
6	MOD-ABS	Module Absent, connect to VeeR or VeeT in the module	4		
7	RS0	Rate select0, optionally control SFP+ receiver. When high, input data rate >4.5Gb/ s; when low, input data rate <=4.5Gb/s	5		
8	LOS	Receiver Loss of Signal Indication	6		
9	RS1	Rate select0, optionally control SFP+ transmitter. When high, input data rate >4.5Gb/s; when low, input data rate <=4.5Gb/s	1		
10	VeeR	Module receiver ground	1		
11	VeeR	Module receiver ground	1		
12	RD-	Receiver inverted data output			
13	RD+	Receiver non-inverted data output			
14	VeeR	Module receiver ground	1		
15	VccR	Module receiver 3.3V supply			
16	VccT	Module transmitter 3.3V supply			

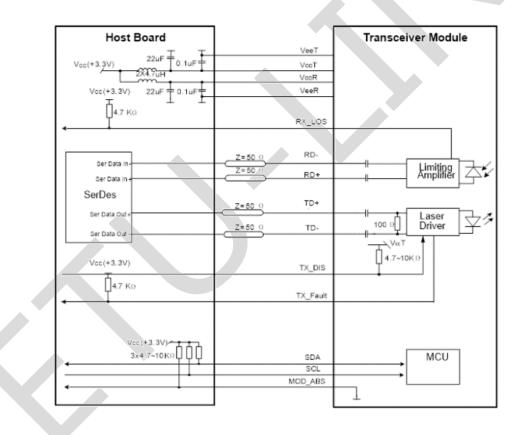
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17	VeeT	Module transmitter ground	1
18	TD+	Transmitter inverted data output	
19	TD-	Transmitter non-inverted data output	
20	VeeT	Module transmitter ground	1

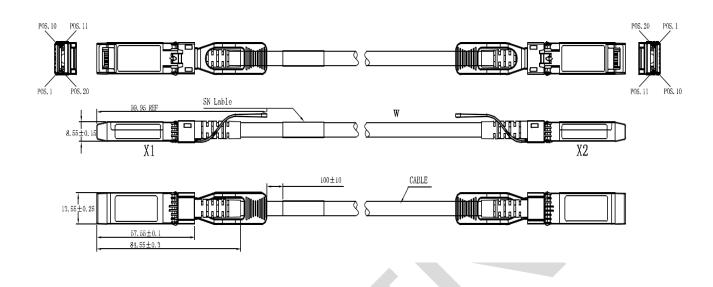
Notes:

- 1. Circuit ground is internally isolated from chassis ground
- 2. Tx FAULT is an open collector/drain output, which should be pulled up with a 4.7k 10k Ohms resistor on the host board if intended for use. Pull up voltage should be between 2.0V to Vcc + 0.3V.A high output indicates a transmitter fault caused by either the TX bias current or the TX output power exceeding the preset alarm thresholds. A low output indicates normal operation. In the low state, the output is pulled to <0.8V.</p>
- 3. Laser output disabled on Tx DIS >2.0V or open, enabled on Tx DIS <0.8V.
- 4. Should be pulled up with $4.7k\Omega$ $10k\Omega$ host board to a voltage between 2.0V and 3.6V. MOD_ABS pulls line low to indicate module is plugged in.
- 5. Internally pulled down per SFF-8431 Rev 4.1.
- 6. LOS is open collector output. It should be pulled up with $4.7k\Omega 10k\Omega$ on host board to a voltage between 2.0V and 3.6V. Logic 0 indicates normal operation; logic 1 indicates loss of signal.



Recommended Interface Circuit

Mechanical Diagram



Revision History

Version No.	Date	Description		
1.0	February 16, 2018	Preliminary datasheet		
2.0	Aug 12,2024	Format change		

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